506896889 09/29/2021

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
SEBASTIEN DUVAL	06/04/2018

RECEIVING PARTY DATA

Name:	BELL HELICOPTER TEXTRON INC.	
Street Address:	POST OFFICE BOX 482	
City:	FORT WORTH	
State/Country:	TEXAS	
Postal Code:	76101	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	17340034

CORRESPONDENCE DATA

Fax Number:

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

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ATTORNEY DOCKET NUMBER:	0021-00260-DIV
NAME OF SUBMITTER:	ALAN DAWSON LIGHTFOOT
SIGNATURE:	/Alan Dawson Lightfoot/
DATE SIGNED:	09/29/2021

Total Attachments: 1

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PATENT 506896889 REEL: 057645 FRAME: 0247

PATENT ASSIGNMENT

WHEREAS, the undersigned, of residence as listed below, has invented certain new and useful improvements for which application is being made for Letters Patent, said application being identified as:

Title of Application;	SPLICE JOINT IN LAMINATE COMPOSITE STRUCTURE
U.S. Application No.:	16/004,371
Filing Date:	June 9, 2018
Attorney Docket No.:	0021-00260

WHEREAS, Bell Helicopter Textron Inc. (hereinafter referred to as "Assignee"), a Delaware corporation, with an address of Post Office Box 482, Fort Worth, Texas 76101, desires to acquire our entire right, title and interest in and to the invention, and in and to the said application and any Letters Patent that may issue thereon;

NOW, THEREFORE, for and in consideration of One Dollar (\$1.00) and other good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I agree to assign and hereby assign to Assignee, all right, title and interest in and to said invention and in and to said application and all patents which may be granted therefor, and all future applications throughout that world that may claim priority to said application, including but not limited to divisions, reexaminations, reissues, continuations, continuations-in-part, and extensions thereof; and I hereby authorize and request the Commissioner of Patents and Trademarks to issue all patents for said invention, or patents resulting therefrom, insofar as our interest is concerned, to Assignee. I also agree to assign and hereby assign to Assignee, all right, title and interest to the invention disclosed in said application throughout the world, including the right to file applications and obtain patents, utility models, industrial models, and designs for said invention in its own name throughout the world including all rights to publish cautionary notices reserving ownership of said invention and all rights to register said invention in appropriate registries; and I further agree to execute any and all powers of attorney, applications, assignments, declarations, affidavits, and any other papers in connection therewith necessary to perfect such right, title and interest in Assignee.

I will communicate to Assignee any facts known to us respecting any improvements; and, at the expense of Assignee, I will testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, continuation-in-part, reissue and substitute applications, make lawful oaths and declarations, and generally do everything possible to vest title in Assignee and to aid Assignee to obtain and enforce proper protection for said invention in all countries. I authorize Assignee's representative to fill in the foregoing blanks for the application number and the filing date once that information becomes known.

This Assignment shall be binding on the parties' successors, assigns and legal representatives.

Full name of inventor	Sedastien Duvai
Inventor's signature	
Residence	2080 rue de l'Echassier, Terrebonne, QC, J7M 1Z1 Canada
Date Assignment executed:	JUE 4" 2018

PATENT REEL: 057645 FRAME: 0248

RECORDED: 09/29/2021